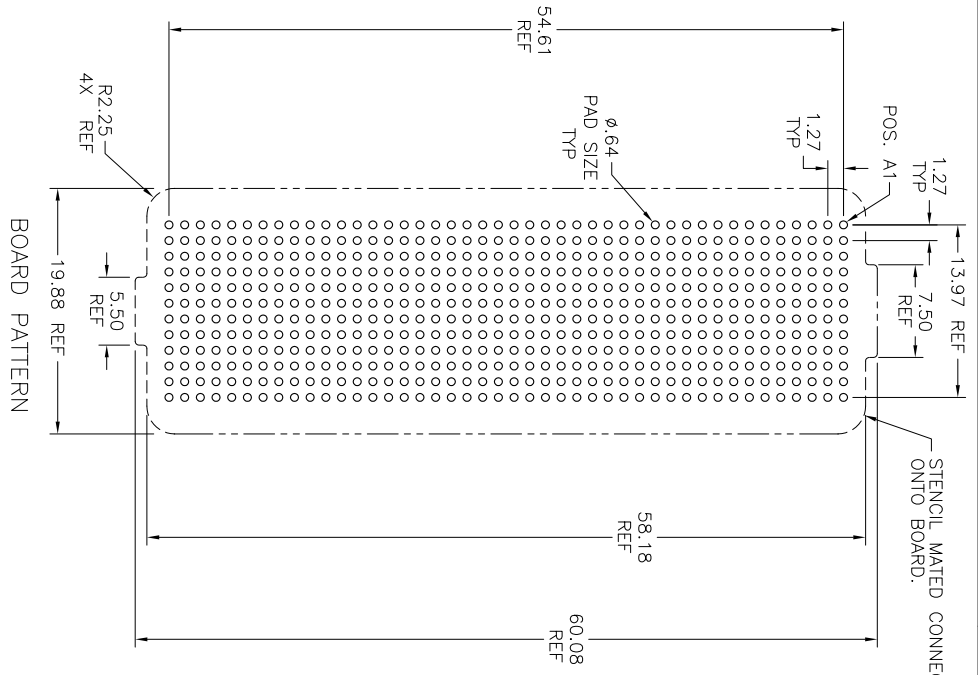


FLAT AREA FOR PICK UP CAP



BOARD PATTERN

STENCIL MATED CONNECTOR OUTLINE ONTO BOARD.

mat'l code	SEE NOTE 1	surface	ASME Y14.5	tolerance	ASME Y14.5	projection	MM	product family	MEG-ARRAY
lit	ecn no	dr	date	tolerances unless otherwise specified				title	6mm RECAPT. ASSY.
G				angles	X+3			12 X 44 = 528 POS.	
				0° ±2'	XXX±051	Scale	1:1	sheet 2 of 3	size A4
		dr	D.INGRAM	2003-04-01				10026846	CUSTOMER Drawing
		engr	D.WHITTING	2003-04-01					
		chr	D.WHITTING	2003-04-01					
		appd	D.WHITTING	2003-04-01					
sheet index	revision	sheet	revision						

PRODUCT NUMBER	PICK-UP CAP (NATURAL OR BLACK COLOR)	CONTACT PLATING AND THICKNESS	SOLDER BALL	NOTES
10026846-001	YES	15u" (.38um) Au	SnPb	
10026846-001LF	YES	15u" (.38um) Au	LEAD FREE	6
10026846-091	YES	15u" (.38um) GXT	SnPb	
10026846-091LF	YES	15u" (.38um) GXT	LEAD FREE	6
10026846-091BF	WITH VENT HOLES	15u" (.38um) GXT	SnPb	
10026846-091BLF	WITH VENT HOLES	15u" (.38um) GXT	LEAD FREE	6
10026846-101	YES	30u" (.76um) Au	SnPb	
10026846-101LF	YES	30u" (.76um) Au	LEAD FREE	6
10026846-191	YES	30u" (.76um) GXT	SnPb	
10026846-191LF	YES	30u" (.76um) GXT	LEAD FREE	6
10026846-201	YES	50u" (1.27um) Au SPECIAL	SnPb	4
10026846-201LF	YES	50u" (1.27um) Au SPECIAL	LEAD FREE	4 AND 6
10026846-291	YES	50u" (1.27um) GXT SPECIAL	SnPb	4
10026846-291LF	YES	50u" (1.27um) GXT SPECIAL	LEAD FREE	4 AND 6

NOTES:

① MATL:  
HOUSING: LCP  
CONTACT: COPPER ALLOY

PLATING:

CONTACT: (SEE TABLE)  
SOLDER BALL: (SEE TABLE)  
EUTECTIC SnPb OR LEAD FREE  
95.5Sn/44g/0.5Cu

② SOLDER BALLS WILL NOT BE PERFECT SPHERICAL SHAPE DUE TO REFLOW ATTACHMENT.

③ MATED HEIGHT EFFECTED BY CUSTOMER'S PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE, & SOLDER PASTE.

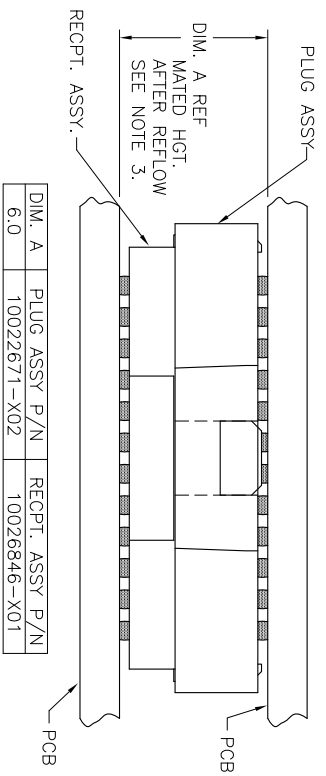
④ PLATING FOR INDICATED -2XX SERIES PRODUCT NUMBERS MEET THE REQUIREMENTS OF GR-1217-CORE, CENTRAL OFFICE ENVIRONMENT, (25 YEAR LIFE EXPECTANCY), THE CONTACT GEOMETRY IN THESE PRODUCT NUMBERS IS SPECIAL, ALSO.

⑤ FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEAD FREE PRODUCT IS THEREFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION

⑥ THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004 PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION

⑦ 10026846-301, -301LF, -401, -401LF, -501, -501LF ARE OBSOLETE.

9. A  $\nabla$  SYMBOL WILL BE NEXT TO ANY DIMENSION, NEW VIEW OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION



MATED HEIGHT AFTER REFLOW IS BASED ON  $\phi$  64mm PAD (METAL-DEFINED) AND .13mm SOLDER PASTE STENCIL THICKNESS. SEE NOTE 3.  
END VIEW - MATED CONNECTORS SCALE NONE

mat'l code	SEE NOTE 1	date	surface	tolerance	projection	product family	title
Ltr	ecp no	dr	ASME Y14.5	ASME Y14.5	$\nabla$	MEG-ARRAY	6mm RECP.T. ASSY.
G			tolerances unless otherwise specified	X+.3	MM		12 X 44 = 528 POS.
				XX+.13			
				XXX+.051	SCALE 1:1		
			DR	D.INGRAM			
			ENGR	D.WHITING			
			CHR	D.WHITING			
			APPR	D.WHITING			
sheet index	revision	sheet					



FCI  
dwg no 10026846  
sheet 3 of 3  
size A4  
CUSTOMER Drawing